

Vishay Siliconix

Dual N-Channel 12-V (D-S) MOSFET

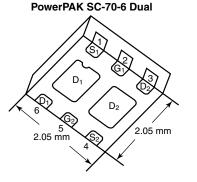
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
12	0.040 at V _{GS} = 4.5 V	4.5				
	0.048 at V _{GS} = 2.5 V	4.5	4.5 nC			
	0.063 at V _{GS} = 1.8 V	4.5				

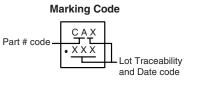


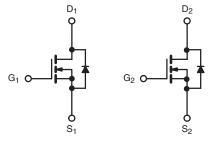
- Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhaced PowerPAK® SC-70 Package
 - Small Footprint Area

APPLICATIONS

Load Switch for Portable Applications







N-Channel MOSFET

Ordering Information: SiA912DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol Unit Parameter Limit **Drain-Source Voltage** V_{DS} 12 V V_{GS} Gate-Source Voltage ± 8 _C = 25 °C 4.5^a T_C = 70 °C 4.5^a Continuous Drain Current (T_{.1} = 150 °C) I_D T_A = 25 °C 4.5^{a, b, c} 4.5^{a, b, c} T_A = 70 °C А Pulsed Drain Current IDM 20 T_C = 25 °C 4.5^a Continuous Source-Drain Diode Current Is T_A = 25 °C 1.6^{b, c} T_C = 25 °C 6.5 T_C = 70 °C 5 Maximum Power Dissipation P_D w T_A = 25 °C 1.9^{b, c} 1.2^{b, c} T_A = 70 °C Operating Junction and Storage Temperature Range - 55 to 150 T_J, T_{stg} °C Soldering Recommendations (Peak Temperature)^{d, e} 260

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Typical Maximum		
Maximum Junction-to-Ambient ^{b, f}	$t \le 5 s$	R _{thJA}	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16	0/11	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

t = 5 s. c.

d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components. Maximum under Steady State conditions is 110 °C/W.

f.



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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•		•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	12			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$ $\Delta V_{GS(th)}/T_J$	- Ι _D = 250 μΑ		12		mV/°C	
V _{GS(th)} Temperature Coefficient				- 2.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4		1.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	ns	
	I _{DSS}	$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	- 20			A	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$		0.033	0.040	1	
		V _{GS} = 2.5 V, I _D = 3.8 A		0.039	0.048	Ω	
Drain-Source On-State Resistance ^a		V _{GS} = 1.8 V, I _D = 1.6 A		0.051	0.063	1	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 6 V, I_{D} = 4.2 A$		13		S	
Dynamic ^b				1	1		
Input Capacitance	C _{iss}			400		pF	
Output Capacitance	C _{oss}	V _{DS} = 6 V, V _{GS} = 0 V, f = 1 MHz		120			
Reverse Transfer Capacitance	C _{rss}			70			
		V _{DS} = 6 V, V _{GS} = 8 V, I _D = 5.5 A		7.5	11.5	1	
Total Gate Charge	Q _g Q _{gs}	$V_{DS} = 6 V, V_{GS} = 4.5 V, I_{D} = 5.5 A$		4.5	6.8	nC	
Gate-Source Charge				0.6			
Gate-Drain Charge	Q _{gd}			0.8			
Gate Resistance	Rg	f = 1 MHz		2.5		Ω	
Turn-on Delay Time	t _{d(on)}			5	10		
Rise Time	t _r	V_{DD} = 6 V, R _L = 1.4 Ω I_D ≅ 4.4 A, V _{GEN} = 4.5 V, R _g = 1 Ω		15	25	ns	
Turn-Off Delay Time	t _{d(off)}			35	55		
Fall Time	t _f	$D = 4.4 \text{ A}, \text{ V}_{\text{GEN}} = 4.3 \text{ V}, \text{ H}_{\text{g}} = 1.22$		15	25		
Turn-on Delay Time	t _{d(on)}			5	10		
Rise Time	t _r			10	15		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 6 V, R_L = 1.6 \Omega$		15	25		
Fall Time	t _f	$I_D \cong 4.4 \text{ A}, V_{GEN} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		10	15		
Drain-Source Body Diode Characteristic	S			1	1	<u> </u>	
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			4.5	A	
Pulse Diode Forward Current	I _{SM}				20		
Body Diode Voltage	V _{SD}	$I_{S} = 4.4 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
ody Diode Beverse Becovery Charge Q			8	20	nC		
Reverse Recovery Fall Time	t _a	$I_F = 4.4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		8.5		ns	
Reverse Recovery Rise Time	t _b	1		6.5		1	

Notes:

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

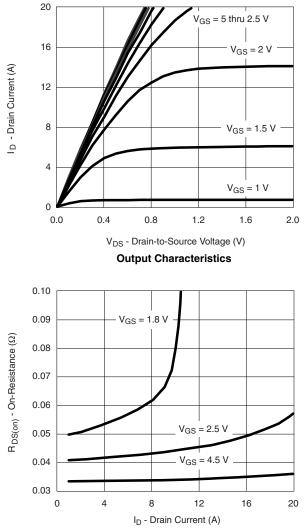
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



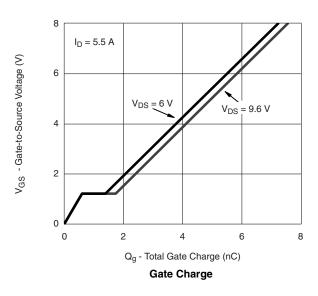


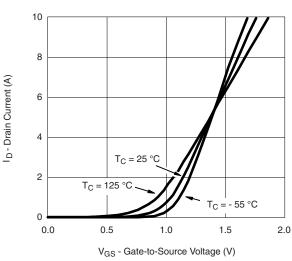
SiA912DJ Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

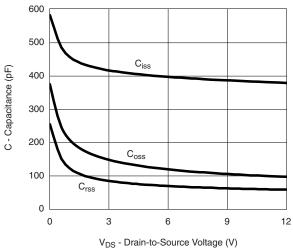


On-Resistance vs. Drain Current and Gate Voltage

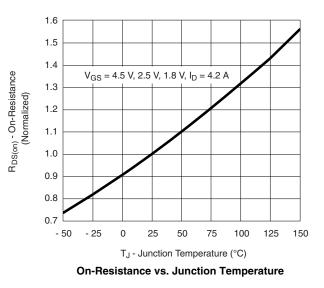




Transfer Characteristics



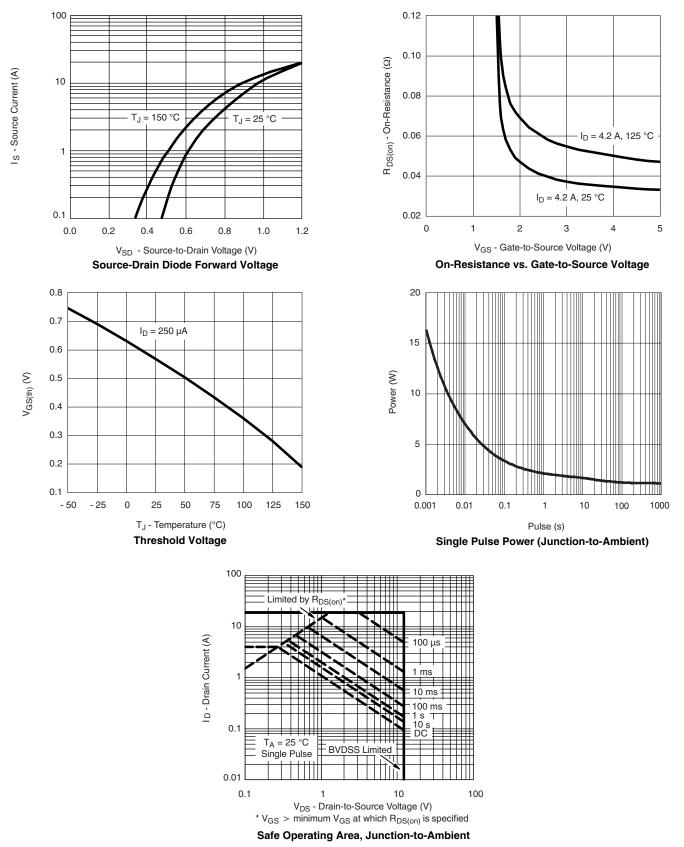
Capacitance

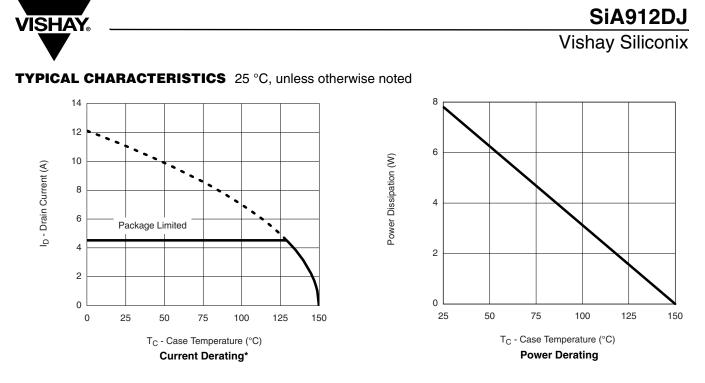




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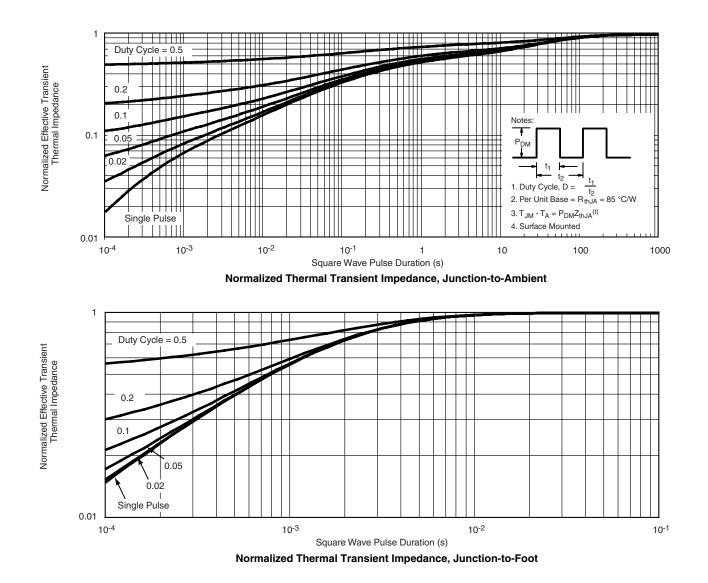


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?74953.



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